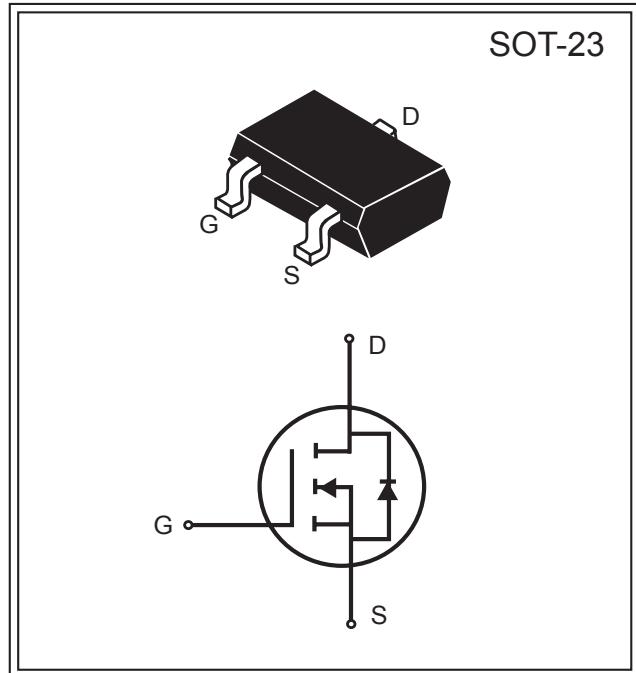


Product Summary		
V <sub>DS</sub> (V)	I <sub>D</sub> (A)	R <sub>DS(ON)</sub> (mΩ) Max
30V	3.5A	40 @ V <sub>GS</sub> = 10V
		60 @ V <sub>GS</sub> = 4.5V



## FEATURES

- ◆ Super high dense cell design for low R<sub>DS(ON)</sub>.
- ◆ Rugged and reliable.
- ◆ SOT-23 package.

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous @ T <sub>C</sub> = 25°C	I <sub>D</sub>	3.5	A
-Pulsed <sup>b</sup>	I <sub>DM</sub>	13	A
Drain-Source Diode Forward Current <sup>a</sup>	I <sub>S</sub>	1.25	A
Maximum Power Dissipation <sup>a</sup>	P <sub>D</sub>	1.25	W
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C

## THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient <sup>a</sup>	R <sub>θJA</sub>	100	°C/W
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South Sea Semiconductor

SSS3400

Electrical Characteristics ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ <sup>c</sup>	Max	Unit
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250 \mu\text{A}$	30			V
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=24\text{V}, \text{V}_{\text{GS}}=0\text{V}$			1	$\mu\text{A}$
Gate-Body Leakage	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm 20\text{V}, \text{V}_{\text{DS}}=0\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=250 \mu\text{A}$	1	1.6	2.5	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=3.5\text{A}$		30	40	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=2\text{A}$		50	60	
On-State Drain Current	$\text{I}_{\text{D}(\text{ON})}$	$\text{V}_{\text{DS}}=5\text{V}, \text{V}_{\text{GS}}=10\text{V}$	10			A
Forward Transconductance	$\text{g}_{\text{FS}}$	$\text{V}_{\text{DS}}=5\text{V}, \text{I}_D=3.5\text{A}$		5		S
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=10\text{V}$		595		$\text{pF}$
Output Capacitance	$\text{C}_{\text{oss}}$	$\text{V}_{\text{GS}}=0\text{V}$		125		
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$	$f=1.0\text{MHz}$		93		
Turn-On Delay Time	$t_{\text{D}(\text{ON})}$	$\text{V}_{\text{DD}}=10\text{V},$ $\text{I}_D=1\text{A},$ $\text{V}_{\text{GS}}=10\text{V},$ $\text{R}_{\text{GEN}}=6\Omega,$ $\text{R}_L=10\Omega$		14		$\text{ns}$
Rise Time	$t_r$			5		
Turn-Off Delay Time	$t_{\text{D}(\text{OFF})}$			20		
Fall Time	$t_f$			9.5		
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{DS}}=10\text{V},$ $\text{I}_D=3.5\text{A},$ $\text{V}_{\text{GS}}=4.5\text{V}$		7		$\text{nC}$
Gate-Source Charge	$\text{Q}_{\text{gs}}$			3		
Gate-Drain Charge	$\text{Q}_{\text{gd}}$			2		
Diode Forward Voltage	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=1.25\text{A}$		0.8	1.2	V

## Notes :

- a. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
- b. Pulse Test : Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
- c. Guaranteed by design, not subject to production testing.



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# SSS3400

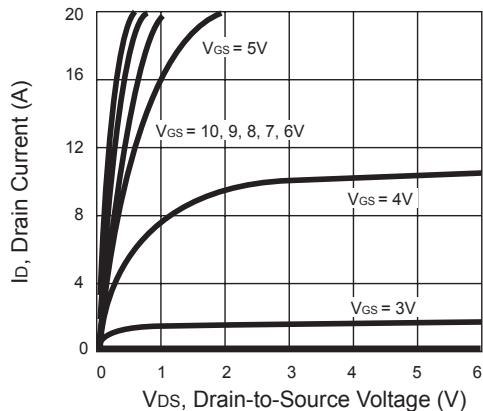


Figure 1. Output Characteristics

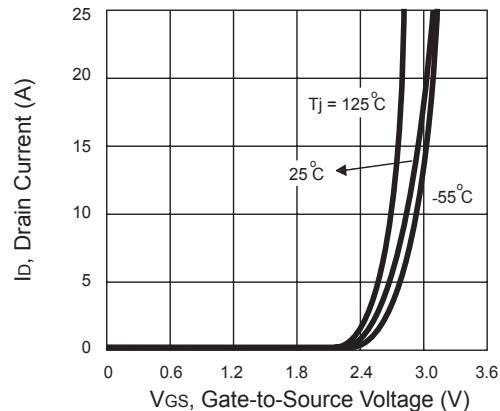


Figure 2. Transfer Characteristics

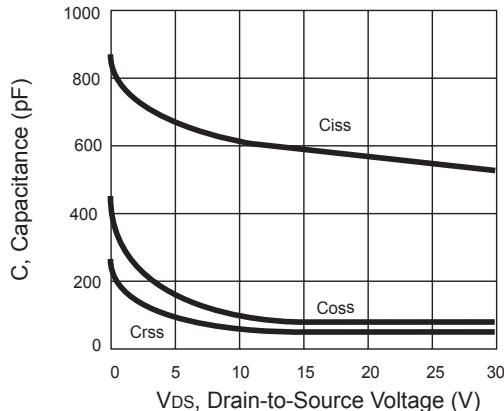


Figure 3. Capacitance

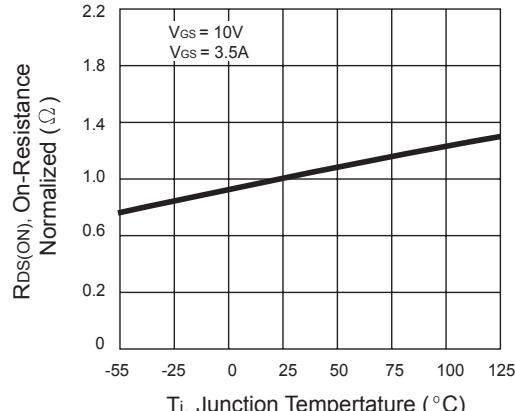


Figure 4. On-Resistance Variation with Temperature

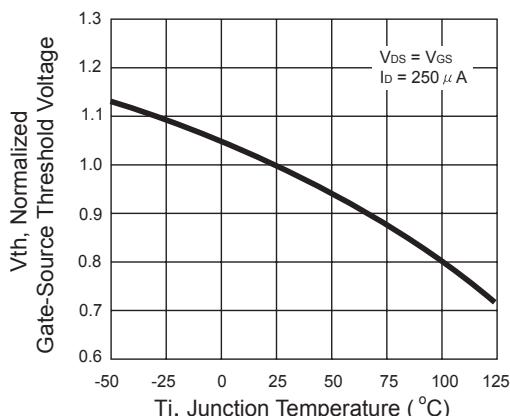


Figure 5. Gate Threshold Variation with Temperature

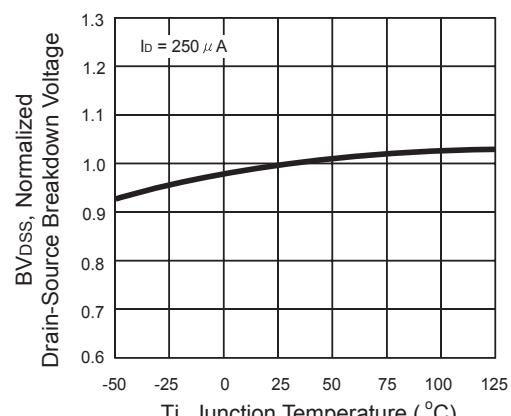


Figure 6. Breakdown Voltage Variation with Temperature

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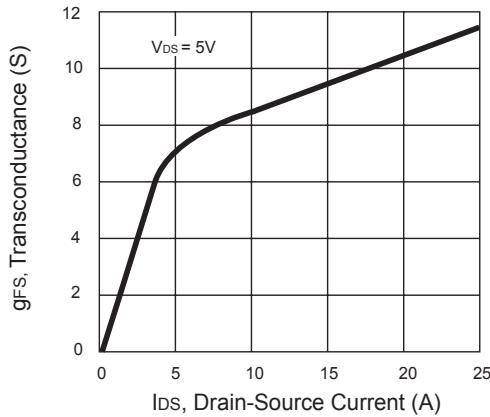


Figure 7. Transconductance Variation with Drain Current

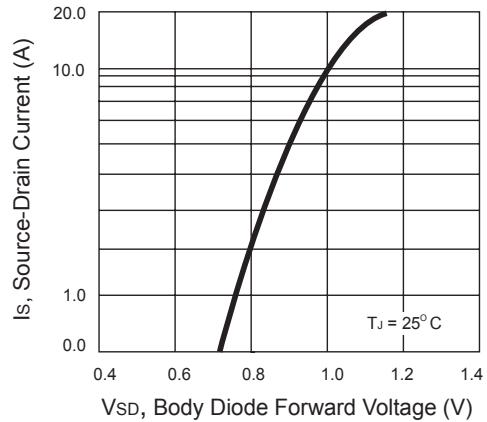


Figure 8. Body Diode Forward Voltage Variation with Source Current

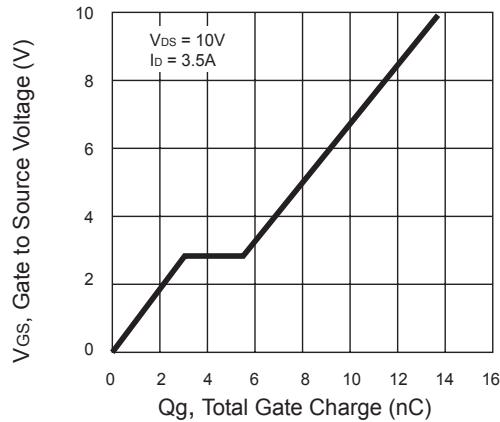


Figure 9. Gate Charge

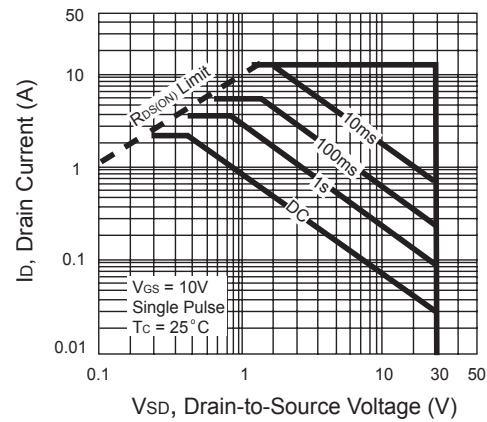


Figure 10. Maximum Safe Operating Area



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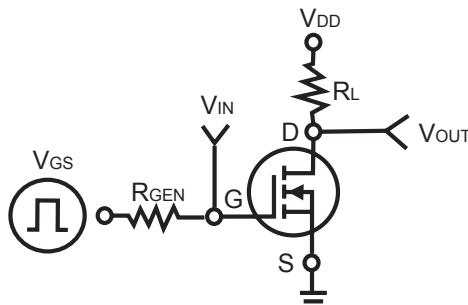


Figure 11. Switching Test Circuit

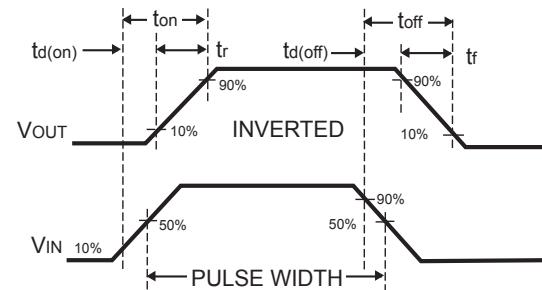


Figure 12. Switching Waveforms

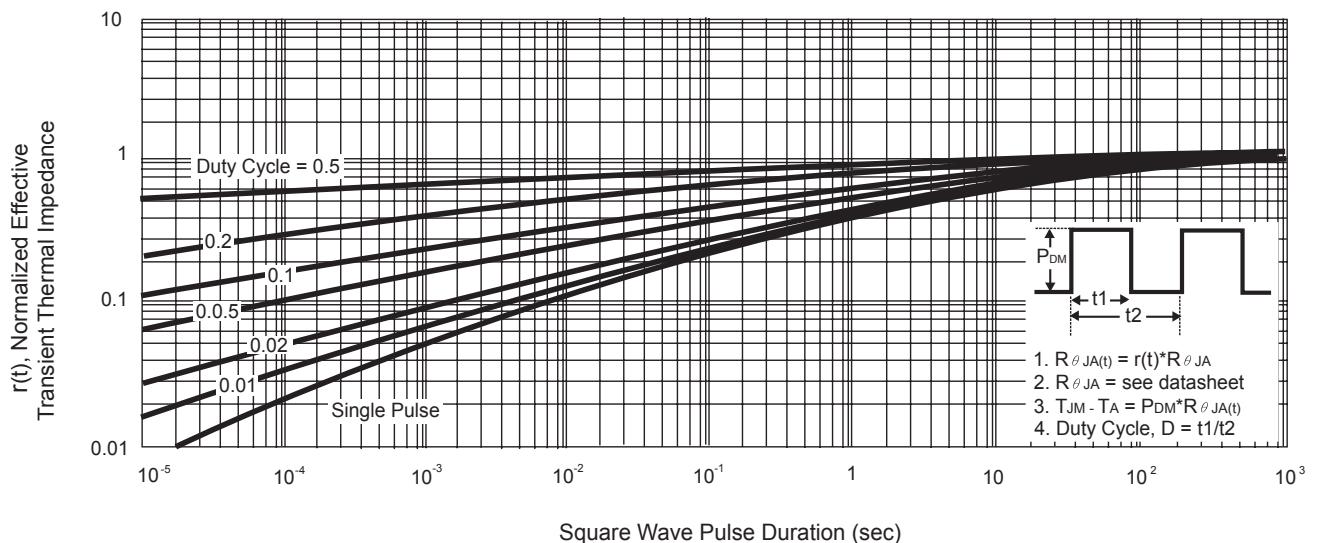


Figure 13. Normalized Thermal Transient Impedance Curve